

Filename: PMP10650\_BOM.xls

Variant: None

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### Drone AUX SMPS

| Designator        | Description  | Manufacturer          | PartNumber              | Quantity |
|-------------------|--|-----------------------|-------------------------|----------|
| !PCB1             | Printed Circuit Board  | Any                   | PMP10650                | 1        |
| C1, C2, C3        | CAP, CERM, 4.7uF, 50V, +/-10%, X7R, 1206                                 | MuRata                | GRM31CR71H475KA12L      | 3        |
| C4, C7            | CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0402                                 | TDK                   | C1005X7R1H104K050BB     | 2        |
| C5                | CAP, CERM, 4.7uF, 16V, +/-10%, X5R, 0603                                 | MuRata                | GRM188R61C475KAAJ       | 1        |
| C6                | CAP, CERM, 0.47uF, 25V, +/-10%, X7R, 0603                                | MuRata                | GRM188R71E474KA12D      | 1        |
| C8                | CAP, CERM, 0.068 uF, 50 V, +/- 10%, X7R, 0603                            | MuRata                | GRM188R71H683KA93D      | 1        |
| C9, C10           | CAP, CERM, 100uF, 6.3V, +/-20%, X5R, 1206                                | Taiyo Yuden           | JMK316BJ107ML-T         | 2        |
| C11               | CAP, CERM, 3300 pF, 50 V, +/- 10%, X7R, 0603                             | MuRata                | GRM188R71H332KA01D      | 1        |
| C12               | CAP, CERM, 330 pF, 50 V, +/- 10%, X7R, 0603                              | Kemet                 | C0603C331K5RACTU        | 1        |
| C13               | CAP, AL, 47uF, 50V, +/-20%, 0.68 ohm, SMD                                | Panasonic             | EEE-FK1H470XP           | 1        |
| C14               | CAP, CERM, 10uF, 50V, +/-10%, X7R, 1210                                  | MuRata                | GRM32ER71H106KA12L      | 1        |
| C15, C16          | CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603                                 | AVX                   | 06035C104KAT2A          | 2        |
| C17               | CAP, CERM, 0.47uF, 10V, +/-10%, X7R, 0603                                | Kemet                 | C0603C474K8RACTU        | 1        |
| C18, C19, C20     | CAP, CERM, 22uF, 16V, +/-20%, X7R, 1210                                  | TDK                   | C3225X7R1C226M          | 3        |
| C21               | CAP, CERM, 1000 pF, 100 V, +/- 10%, X7R, 0603                            | AVX                   | 06031C102KAT2A          | 1        |
| C22               | CAP, CERM, 2.2uF, 10V, +/-10%, X7R, 0603                                 | MuRata                | GRM188R71A225KE15D      | 1        |
| FID1, FID2, FID3  | Fiducial mark. There is nothing to buy or mount.                         | N/A                   | N/A                     | 3        |
| H9, H10, H11, H12 | Bumpon, Hemisphere, 0.44 X 0.20, Clear                                   | 3M                    | SJ-5303 (CLEAR)         | 4        |
| L1                | Inductor, Shielded, Composite, 10 uH, 15.5 A, 0.01 ohm, SMD              | Coilcraft             | XAL1010-103MEB          | 1        |
| L2                | Inductor, Shielded, Powdered Iron, 2.2uH, 5.3A, 0.021 ohm, SMD           | Toko                  | FDV0630-2R2M            | 1        |
| LBL1              | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll | Brady                 | THT-14-423-10           | 1        |
| Q1                | MOSFET, N-CH, 60 V, 15 A, SON 5x6mm                                      | Texas Instruments     | CSD18563Q5A             | 1        |
| Q2                | MOSFET, N-CH, 100V, 71A, PG-TDSON-8                                      | Infineon Technologies | BSC123N10LS G           | 1        |
| R1, R3            | RES, 0 ohm, 5%, 0.063W, 0402   | Vishay-Dale           | CRCW04020000Z0ED        | 2        |
| R2                | RES, 156 k, 0.1%, 0.1 W, 0603  | Yageo America         | RT0603BRD07156KL        | 1        |
| R4                | RES, 1.76k ohm, 0.1%, 0.125W, 0805                                       | Yageo America         | RT0805BRD071K76L        | 1        |
| R5                | RES, 73.2k ohm, 1%, 0.063W, 0402   | Vishay-Dale           | CRCW040273K2FKED        | 1        |
| R6                | RES, 180 k, 5%, 0.1 W, 0603  | Vishay-Dale           | CRCW0603180KJNEA        | 1        |
| R7                | RES, 10.0k ohm, 1%, 0.063W, 0402   | Vishay-Dale           | CRCW040210K0FKED        | 1        |
| R9, R11           | RES, 0 ohm, 5%, 0.1W, 0603   | Vishay-Dale           | CRCW06030000Z0EA        | 2        |
| R10, R13          | RES, 100k ohm, 1%, 0.1W, 0603  | Vishay-Dale           | CRCW0603100KFKEA        | 2        |
| R12               | RES, 4.99, 1%, 0.1 W, 0603   | Vishay-Dale           | CRCW06034R99FKEA        | 1        |
| R14               | RES, 50.5 k, 0.1%, 0.1 W, 0603   | Yageo America         | RT0603BRD0750K5L        | 1        |
| R15               | RES, 12.7 k, 1%, 0.1 W, 0603   | Vishay-Dale           | CRCW060312K7FKEA        | 1        |
| TP1               | Test Point, Multipurpose, White, TH                                      | Keystone              | 5012                    | 1        |
| U1                | SIMPLE SWITCHER® CONTROLLER, 42V Synchronous Step-Down, 14-pin TSSOP-EP  | Texas Instruments     | LM3150MH                | 1        |
| U2                | 6th GENERATION BUCK REGULATOR, PWP0016H                                  | Texas Instruments     | LM53603AQPWP            | 1        |
| VI+1, VI-1        | PCB Pin, TH  | Mill-Max              | 3125-2-00-34-00-00-08-0 | 2        |

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